

N-TEM54

Non-Silicone Thermal Conductive RF Absorber Pad

LiPOLY N-TEM54 is a thermally conductive absorber based upon soft magnetic materials dispersed in a non-silicone resin. It has a thermal conductivity of 4.0 W/m*K and dissipates electromagnetic radia- tion rapidly to mitigate against EMI issues.

■ FEATURES

/ Thermal conductivity: 4.0 W/m*K / Excellent absorption characteristics

/ Naturally tacky

/ Reworkable

■ TYPICAL APPLICATION

/ IC, CPU, MOS, LED, M/B, Heat sink / LCD-TV, Notebook PC, PC, Telecom device, Wireless hub / DDR II module, DVD applications, Hand-set applications

/ 5G base station & infrastructure

/ EV electric vehicle

■ SPECIFICATIONS

/ Sheet form / Die-cut parts

■ FREQUENCY APPLICATION

2.4 GHz Wi-Fi Router , Bluetooth3.5 GHz 5G Mobile Networks

5.0 GHz Wi-Fi Router

6.0 GHz Wi-Fi Router

12~18 GHz Low Earth Orbit (LEO) System

28 GHz 5G Mobile Networks 39 GHz 5G Mobile Networks

■ TYPICAL PROPERTIES

	PROPERTY	N-TEM54	TEST METHOD	UNIT
	Color	Dark Gray	Visual	-
	Surface tack 2-side/1-side	2	-	-
	Thickness	Customized	ASTM D374	mm
	Density	3.6	ASTM D792	g/cm³
	Hardness	75	ASTM D2240	Shore OO
	TML	<0.8	By LiPOLY	%
	Application temperature	-60~130	-	°C
	ROHS & REACH	Compliant	-	-
	COMPRESSION@1.0mm			
	Deflection @10 psi	3	ASTM D5470 modify	%
	Deflection @20 psi	5	ASTM D5470 modify	%
	Deflection @30 psi	8	ASTM D5470 modify	%
	Deflection @40 psi	12	ASTM D5470 modify	%
	Deflection @50 psi	17	ASTM D5470 modify	%
<	EMI Attenuation @1.0mm			
	EMI attenuation@ 2.4 GHz	12	ASTM D4935 modify	dB/cm
	EMI attenuation@ 3.5 GHz	9	ASTM D4935 modify	dB/cm
-	EMI attenuation@ 5.0 GHz	22	ASTM D4935 modify	dB/cm
	EMI attenuation@ 6.0 GHz	18	ASTM D4935 modify	dB/cm
	EMI attenuation@ 12 GHz	47	ASTM D4935 modify	dB/cm
-	EMI attenuation@ 18 GHz	53	ASTM D4935 modify	dB/cm
	EMI attenuation@ 28 GHz	118	ASTM D4935 modify	dB/cm
	EMI attenuation@ 39 GHz	49	ASTM D4935 modify	dB/cm
	ELECTRICAL			
	Surface resistivity	>1011	ASTM D257	Ohm
	Volume resistivity	>1010	ASTM D257	Ohm-m
	THERMAL			
	Thermal Conductivity	4.0	ASTM D5470	W/m*K
	Thermal impedance@10 psi	0.419	ASTM D5470	°C-in²/ W
	Thermal impedance@20 psi	0.399	ASTM D5470	°C-in²/ W
	Thermal impedance@30 psi	0.377	ASTM D5470	°C-in²/ W
	Thermal impedance@40 psi	0.357	ASTM D5470	°C-in²/ W
	Thermal impedance@50 psi	0.338	ASTM D5470	°C-in²/ W

Attenuation

400 300 100 -100 -200 0 5 10 15 20 25 30 35 40 45 50

Thermal Resistance vs. Pressure vs. Deflection

